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Kind regards,

Team Nexperia



PBSS4160V

60 V, 1 A NPN low V_{CEsat} (BISS) transistor Rev. 03 — 11 December 2009

Product data sheet

Product profile 1.

1.1 General description

Low V_{CEsat} (BISS) NPN transistor in a SOT666 plastic package.

PNP complement: PBSS5160V.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High efficiency, reduces heat generation
- Reduces printed-circuit board area required
- Cost effective replacement for medium power transistor BCP55 and BCX55

1.3 Applications

- Major application segments:
 - Automotive
 - ◆ Telecom infrastructure
 - Industrial
- Power management:
 - DC-to-DC conversion
 - Supply line switching
- Peripheral driver:
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load driver (e.g. relays, buzzers and motors)

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	60	V
I _C	collector current (DC)		[1]	-	-	1	Α
I _{CM}	peak collector current	$t = 1 \text{ ms or limited by } T_{j(max)}$		-	-	2	Α
R _{CEsat}	equivalent on-resistance	$I_C = 1 A$; $I_B = 100 \text{ mA}$	[2]	-	200	250	$m\Omega$

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, 1 cm² collector mounting pad.

[2] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$



60 V, 1 A NPN low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2. Discrete pinning

Table 2.	Discrete pinning		
Pin	Description	Simplified outline Symbol	
1, 2, 5, 6	collector		
3	base	6 5 4 1, 2, 5,	, 6
4	emitter	3 — 4 1 2 3 symon	14

3. Ordering information

Table 3. Ordering information

Type number	Package	Package				
	Name	Description	Version			
PBSS4160V	-	plastic surface mounted package; 6 leads	SOT666			

4. Marking

Table 4. Marking codes

Type number	Marking code
PBSS4160V	41

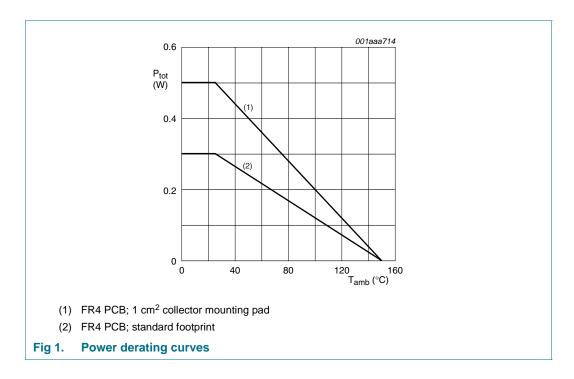
60 V, 1 A NPN low V_{CEsat} (BISS) transistor

5. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	80	V
V_{CEO}	collector-emitter voltage	open base	-	60	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current (DC)		<u>[1]</u> _	0.9	Α
			[2]	1	
I _{CM}	peak collector current	$t = 1$ ms or limited by $T_{j(max)}$	-	2	Α
I _B	base current (DC)		-	300	mA
I _{BM}	peak base current	$t_p \leq 300~\mu s;~\delta \leq 0.02$	-	1	Α
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	<u>[1]</u> _	300	mW
			[2]	500	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, 1 cm² collector mounting pad.



60 V, 1 A NPN low V_{CEsat} (BISS) transistor

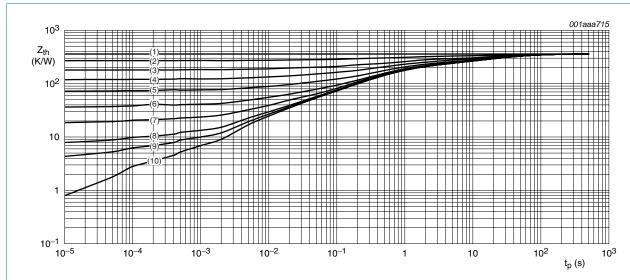
4 of 14

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction	in free air	[1]	-	-	415	K/W
	to ambient		[2]	-	-	250	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, 1 cm² collector mounting pad.



Mounted on FR4 PCB; standard footprint

- (1) $\delta = 1$
- (2) $\delta = 0.75$
- (3) $\delta = 0.5$
- (4) $\delta = 0.33$
- $\delta = 0.2$
- (6) $\delta = 0.1$
- (7) $\delta = 0.05$
- (8) $\delta = 0.02$
- (9) $\delta = 0.01$
- (10) $\delta = 0$

Product data sheet

Transient thermal impedance as a function of pulse time; typical values Fig 2.

60 V, 1 A NPN low V_{CEsat} (BISS) transistor

7. Characteristics

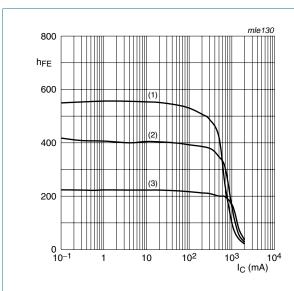
Table 7. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I_{CBO}	collector-base	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
cut-off current	cut-off current	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$		-	-	50	μΑ
I _{CES}	collector-emitter cut-off current	$V_{CE} = 60 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$		250	400	-	
		$V_{CE} = 5 \text{ V}; I_{C} = 500 \text{ mA}$	<u>[1]</u>	200	350	-	
		V _{CE} = 5 V; I _C = 1 A	<u>[1]</u>	100	150	-	
V_{CEsat}	collector-emitter	$I_C = 100 \text{ mA}; I_B = 1 \text{ mA}$		-	90	110	mV
	saturation voltage	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$		-	110	140	mV
		I _C = 1 A; I _B = 100 mA	<u>[1]</u>	-	200	250	mV
V_{BEsat}	base-emitter saturation voltage	$I_C = 1 \text{ A}; I_B = 50 \text{ mA}$		-	0.95	1.1	V
R _{CEsat}	equivalent on-resistance	$I_C = 1 \text{ A}; I_B = 100 \text{ mA}$	<u>[1]</u>	-	200	250	mΩ
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ A}$		-	0.82	0.9	V
t _d	delay time	$V_{CC} = 10 \text{ V}; I_C = 0.5 \text{ A};$		-	11	-	ns
t _r	rise time	$I_{Bon} = 25 \text{ mA}; I_{Boff} = -25 \text{ mA}$		-	78	-	ns
t _{on}	turn-on time			-	90	-	ns
t _s	storage time			-	340	-	ns
t _f	fall time			-	160	-	ns
t _{off}	turn-off time			-	500	-	ns
f _T	transition frequency	$I_C = 50 \text{ mA}; V_{CE} = 10 \text{ V};$ f = 100 MHz		150	220	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A};$ f = 1 MHz		-	5.5	10	pF

^[1] Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

60 V, 1 A NPN low V_{CEsat} (BISS) transistor



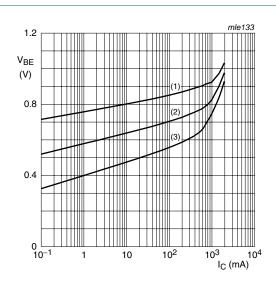
$$V_{CE} = 5 V$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

DC current gain as a function of collector Fig 3. current; typical values



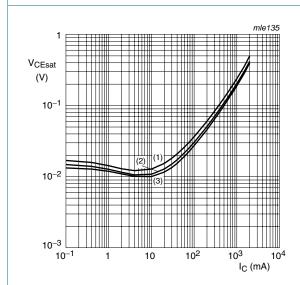
$$V_{CE} = 5 V$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 4. Base-emitter voltage as a function of collector current; typical values



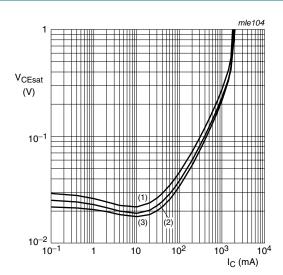
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 5. Collector-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B}=20$$

(1)
$$T_{amb} = 100 \, ^{\circ}C$$

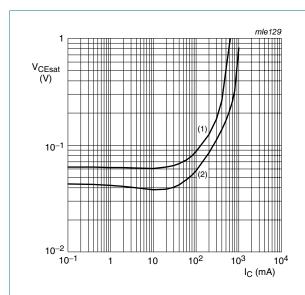
(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 6. Collector-emitter saturation voltage as a function of collector current; typical values

6 of 14

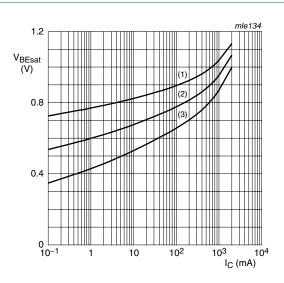
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$$T_{amb} = 25 \, ^{\circ}C$$

- (1) $I_C/I_B = 100$
- (2) $I_C/I_B = 50$

Fig 7. Collector-emitter saturation voltage as a function of collector current; typical values

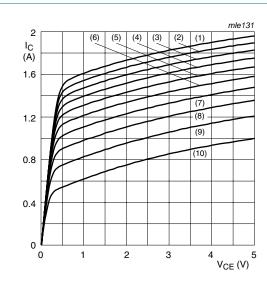


$$I_{\rm C}/I_{\rm B}=20$$

- (1) $T_{amb} = -55$ °C
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 100 \, ^{\circ}C$

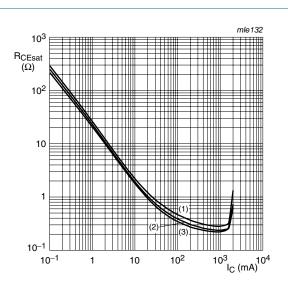
Base-emitter saturation voltage as a function Fig 8. of collector current; typical values

60 V, 1 A NPN low V_{CEsat} (BISS) transistor



$$T_{amb} = 25 \, ^{\circ}C$$

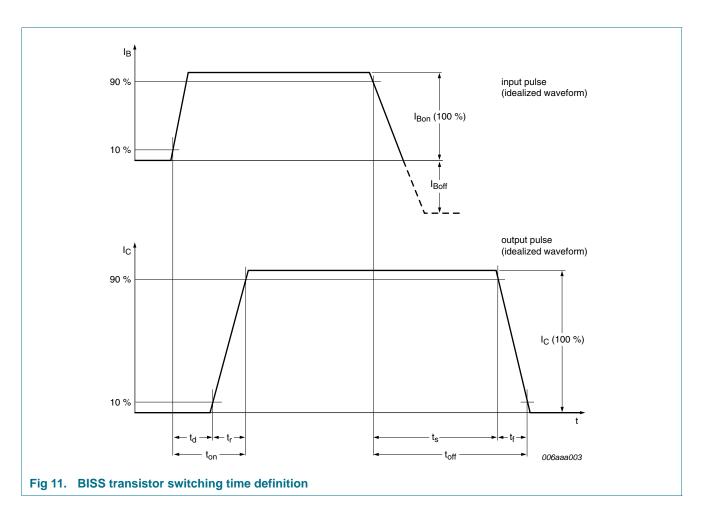
- (1) $I_B = 60 \text{ mA}$
- (2) $I_B = 54 \text{ mA}$
- (3) $I_B = 48 \text{ mA}$
- (4) $I_B = 42 \text{ mA}$
- (5) $I_B = 36 \text{ mA}$
- (6) $I_B = 30 \text{ mA}$
- (7) $I_B = 24 \text{ mA}$ (8) $I_B = 18 \text{ mA}$
- (9) $I_B = 12 \text{ mA}$
- (10) $I_B = 6 \text{ mA}$
- Fig 9. Collector current as a function of collector-emitter voltage; typical values

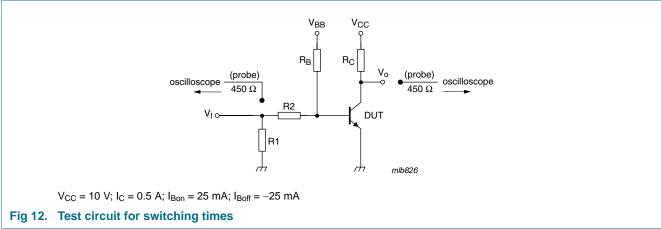


- $I_{\rm C}/I_{\rm B}=20$
- (1) $T_{amb} = 100 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 10. Equivalent on-resistance as a function of collector current; typical values

60 V, 1 A NPN low V_{CEsat} (BISS) transistor





60 V, 1 A NPN low V_{CEsat} (BISS) transistor

Package outline

Plastic surface-mounted package; 6 leads

SOT666

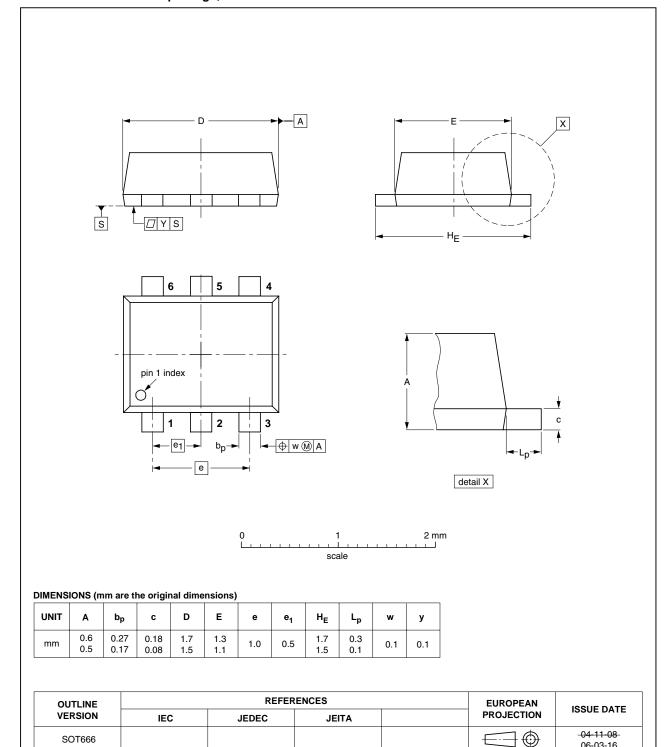


Fig 13. Package outline SOT666

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SOT666

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60 V, 1 A NPN low V_{CEsat} (BISS) transistor

9. Packing information

Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity
			4000
PBSS4160V	SOT666	4 mm pitch, 8 mm tape and reel	-115

^[1] For further information and the availability of packing methods, see Section 12.

60 V, 1 A NPN low V_{CEsat} (BISS) transistor

10. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4160V_3	20091211	Product data sheet	-	PBSS4160V_2
Modifications:	 Modifications: This data sheet was changed to reflect the new company name NXP Semiconomic including new legal definitions and disclaimers. No changes were made to the content. 			
		te pinning": updated		
	 Figure 13 "Pac 	kage outline SOT666": upo	lated	
PBSS4160V_2	20050131	Product data sheet	-	PBSS4160V_1
PBSS4160V_1	20040423	Objective data sheet	-	-

60 V, 1 A NPN low V_{CEsat} (BISS) transistor

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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PBSS4160V_3

60 V, 1 A NPN low V_{CEsat} (BISS) transistor

13. Contents

1	Product profile
1.1	General description 1
1.2	Features
1.3	Applications
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values
6	Thermal characteristics 4
7	Characteristics 5
8	Package outline
9	Packing information 11
10	Revision history
11	Legal information
11.1	Data sheet status
11.2	Definitions
11.3	Disclaimers
11.4	Trademarks 13
12	Contact information
13	Contents

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